3.3V 100/133 MHz Differential 1:19 HCSL Clock ZDB/Fanout Buffer for PCle[®]

Description

The NB3N1900K differential clock buffers are designed to work in conjunction with a PCIe compliant source clock synthesizer to provide point—to—point clocks to multiple agents. The device is capable of distributing the reference clocks for Intel[®] QuickPath Interconnect (Intel QPI), PCIe Gen1, Gen2, Gen3. The NB3N1900K internal PLL is optimized to support 100 MHz and 133 MHz frequency operation. The NB3N1900K supports HCSL output levels.

Features

- Fixed Feedback Path for Lowest Input-to-Output Delay
- Eight Dedicated OE# Pins for Hardware Control of Outputs
- PLL Bypass Configurable for PLL or Fanout Operation
- Selectable PLL Bandwidth
- Spread Spectrum Compatible: Tracks Input Clock Spreading for Low EMI
- SMBus Programmable Configurations
- 100 MHz and 133 MHz PLL Mode to Meet the Next Generation PCIe Gen2 / Gen 3 and Intel QPI Phase Jitter
- 2 Tri-Level Addresses Selection (Nine SMBUS Addresses)
- Cycle–to–Cycle Jitter: < 50 ps
- Output-to-Output Skew: < 65 ps
- Input-to-Output Delay: Fixed at 0 ps
- Input-to-Output Delay Variation: < 50 ps
- Phase Jitter: PCIe Gen3 < 1 ps rms
- Phase Jitter: QPI 9.6GB/s < 0.2 ps rms
- QFN 72-pin Package, 10 mm x 10 mm
- These are Pb–Free Devices



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QFN72 MN SUFFIX CASE 485DK

MARKING DIAGRAM*

NB3N 1900K AWLYYWWG

NB3N1900K = Specific Device Code

= Assembly Location

WL = Wafer Lot
YY = Year
WW = Work Week
G = Pb-Free Package

ORDERING INFORMATION

See detailed ordering and shipping information on page 20 of this data sheet.

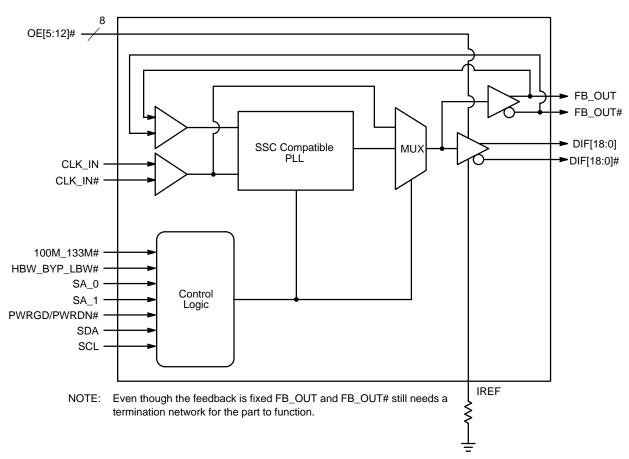
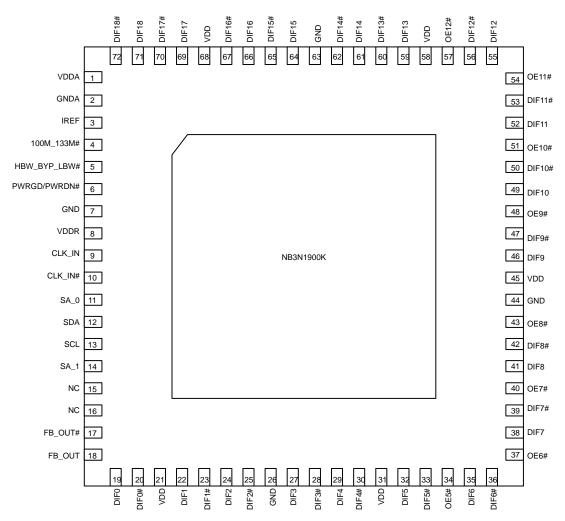


Figure 1. Simplified Block Diagram of NB3N1900K



FB_OUT pins loaded the same as the DIF outputs.

Figure 2. Pin Configuration (Top View)

Table 1. PLL OPERATING MODE READBACK TABLE

HBW_BYP_LBW#	Byte0, bit 7	Byte 0, bit 6
Low (Low BW)	0	0
Mid (Bypass)	0	1
High (High BW)	1	1

Table 2. POWER CONNECTIONS

Pin Nu	ımber	
VDD	GND	Description
1	2	Analog PLL
8	7	Analog Input
21, 31, 45, 58, 68	26, 44, 63	DIF clocks

Table 3. FUNCTIONALITY AT POWER UP (PLL MODE)

100M_133M#	CLK_IN (MHz)	DIF (MHz)
1	100.00	CLK_IN
0	133.33	CLK_IN

Table 4. NB3N1900K SMBus ADDRESSING

Р	1 SMBus Address – 8	
SA_1	SA_0	(Rd/Wrt bit = 0)
0	0	D8
0	М	DA
0	1	DE
M	0	C2
M	М	C4
M	1	C6
1	0	CA
1	М	CC
1	1	CE

Table 5. PLL OPERATING MODE

HBW_BYP_LBW#	MODE
Low	PLL Lo BW
Mid	Bypass
High	PLL Hi BW

NOTE: PLL is OFF in Bypass

Table 6. MODE TRI-LEVEL INPUT THRESHOLD

Level	Voltage
Low	< 0.8 V
Mid	1.2 < Vin < 1.8 V
High	Vin > 2.2 V

Table 7. PIN DESCRIPTION

1 VDDA PWR 3.3 V power for the PLL core. 2 GNDA PWR Ground pin for the PLL core. 3 IREF OUT This pin establishes the reference for the differential current-mode or requires a fixed precision resistor to ground. 475 D is the standard v differential impedance. Other impedances require different values. See data sheet. 4 100M_133M# IN Input to select Departing frequency. 5 HBW_BYP_LBW# IN See PLL Operating Mode Table for Details. 6 PWRGD/PWRDN# IN Notifies device to sample latched inputs and start up on first high as Power Down Mode on subsequent assertions. Low enters Power Down Mode on Subsequent Power Subsequent Power Subsequent Power Subsequent Power Subseque	
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Power Down Mode on subsequent assertions. Low enters Power Down Results of the power of the pow	
8 VDDR PWR 3.3 V power for differential input clock (receiver). This VDD should be analog power rail and filtered appropriately. 9 CLK_IN IN 0.7 V Differential true input 10 CLK_IN# IN 0.7 V Differential complementary Input 11 SA_0 IN SMBus address bit. This is a tri-level input that works in conjunction to decode 1 of 9 SMBus Addresses. 12 SDA I/O Data pin of SMBus circuitry, 5V tolerant 13 SCL IN Clock pin of SMBus circuitry, 5V tolerant 14 SA_1 IN SMBus address bit. This is a tri-level input that works in conjunction to decode 1 of 9 SMBus Addresses. 15 NC N/A No Connection. 16 NC N/A No Connection. 17 FB_OUT# OUT Complementary half of differential feedback output, provides feedbar PLL for synchronization with input clock to eliminate phase error. 18 FB_OUT OUT True half of differential feedback output, provides feedbar PLL for synchronization with the input clock to eliminate phase error. 19 DIFO OUT 0.7 V differential true clock output 20 DIFO# OUT 0.7 V differential true clock output 21 VDD PWR Power supply, nominal 3.3 V 22 DIF1# OUT 0.7 V differential true clock output 23 DIF1# OUT 0.7 V differential true clock output 24 DIF2 OUT 0.7 V differential complementary clock output 25 DIF2# OUT 0.7 V differential true clock output 26 GND PWR Ground pin. 27 DIF3 OUT 0.7 V differential true clock output 28 DIF3# OUT 0.7 V differential true clock output 29 DIF4# OUT 0.7 V differential true clock output 30 DIF4# OUT 0.7 V differential true clock output	
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30 DIF4# OUT 0.7 V differential complementary clock output	
31 VDD PWR Power supply, nominal 3.3 V	
32 DIF5 OUT 0.7 V differential true clock output	
33 DIF5# OUT 0.7 V differential complementary clock output	
OE5# Active low input for enabling DIF pair 5. 1 = disable outputs, 0 = enable outputs	
35 DIF6 OUT 0.7 V differential true clock output	
36 DIF6# OUT 0.7 V differential complementary clock output	
37 OE6# IN Active low input for enabling DIF pair 6. 1 =disable outputs, 0 = enable outputs	

Table 7. PIN DESCRIPTION

Pin#	Pin Name	Pin Type	Description
38	DIF7	OUT	0.7 V differential true clock output
39	DIF7#	OUT	0.7 V differential complementary clock output
40	OE7#	IN	Active low input for enabling DIF pair 7. 1 = disable outputs, 0 = enable outputs
41	DIF8	OUT	0.7 V differential true clock output
42	DIF8#	OUT	0.7 V differential complementary clock output
43	OE8#	IN	Active low input for enabling DIF pair 8. 1 = disable outputs, 0 = enable outputs
44	GND	PWR	Ground pin.
45	VDD	PWR	Power supply, nominal 3.3 V
46	DIF9	OUT	0.7 V differential true clock output
47	DIF9#	OUT	0.7 V differential complementary clock output
48	OE9#	IN	Active low input for enabling DIF pair 9. 1 = disable outputs, 0 = enable outputs
49	DIF10	OUT	0.7 V differential true clock output
50	DIF10#	OUT	0.7 V differential complementary clock output
51	OE10#	IN	Active low input for enabling DIF pair 10. 1 = disable outputs, 0 = enable outputs
52	DIF11	OUT	0.7 V differential true clock output
53	DIF11#	OUT	0.7 V differential complementary clock output
54	OE11#	IN	Active low input for enabling DIF pair 11. 1 = disable outputs, 0 = enable outputs
55	DIF12	OUT	0.7 V differential true clock output
56	DIF12#	OUT	0.7 V differential complementary clock output
57	OE12#	IN	Active low input for enabling DIF pair 12. 1 = disable outputs, 0 = enable outputs
58	VDD	PWR	Power supply, nominal 3.3 V
59	DIF13	OUT	0.7 V differential true clock output
60	DIF13#	OUT	0.7 V differential complementary clock output
61	DIF14	OUT	0.7 V differential true clock output
62	DIF14#	OUT	0.7 V differential complementary clock output
63	GND	PWR	Ground pin.
64	DIF15	OUT	0.7 V differential true clock output
65	DIF15#	OUT	0.7 V differential complementary clock output
66	DIF16	OUT	0.7 V differential true clock output
67	DIF16#	OUT	0.7 V differential complementary clock output
68	VDD	PWR	Power supply, nominal 3.3 V
69	DIF17	OUT	0.7 V differential true clock output
70	DIF17#	OUT	0.7 V differential complementary clock output
71	DIF18	OUT	0.7 V differential true clock output
72	DIF18#	OUT	0.7 V differential complementary clock output

Table 8. ABSOLUTE MAXIMUM RATINGS (Note 1)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{DDA}	3.3 V Core Supply Voltage (Note 2)				4.6	V
V_{DD}	3.3 V Logic Supply Voltage (Note 2)				4.6	V
V _{IL}	Input Low Voltage		GND - 0.5			V
V _{IH}	Input High Voltage	Except for SMBus interface			V _{DD} + 0.5	V
V_{IHSMB}	Input High Voltage	SMBus clock and data pins			5.5	V
T _s	Storage Temperature		-65		150	°C
T _J	Junction Temperature				125	°C
T _c	Case Temperature				130	°C
ESD	ESD protection	Human Body Model	2000			V
θЈА	Thermal Resistance Junction-to-Ambient	Still air		18.1		°C/W
θЈС	Thermal Resistance Junction-to-Case			5.0		°C/W

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Guaranteed by design and characterization, not tested in production.

2. Operation under these conditions is neither implied nor guaranteed.

Table 9. ELECTRICAL CHARACTERISTICS - INPUT/SUPPLY/COMMON PARAMETERS

(V_{DD} = V_{DDA} = 3.3 V $\pm 5\%$, T_A = -10° C to $+70^{\circ}$ C), See Test Loads for Loading Conditions.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{IH}	Input High Voltage	Single-ended inputs, except SMBus, low threshold and tri-level inputs (Note 3)	2		V _{DD} + 0.3	V
V _{IL}	Input Low Voltage	Single-ended inputs, except SMBus, low threshold and tri-level inputs (Note 3)	GND - 0.3		0.8	V
V _{IH_FS} (Note 4)	Input High Voltage		0.7		V _{DD} + 0.3	V
V _{IL_FS} (Note 4)	Input Low Voltage		GND - 0.3		0.35	V
I _{IN}	Input Current	Single–ended inputs, V_{IN} = GND, V_{IN} = V_{DD} (Note 3)	-5		5	μΑ
F _{IBYP}		V _{DD} = 3.3 V, Bypass mode (Notes 3, 5 and 6)	33		400	MHz
F _{IPLL}	Input Frequency	V _{DD} = 3.3 V, 100.00 MHz PLL mode (Note 5)	99	100.00	101	MHz
F _{IPLL}		V _{DD} = 3.3 V, 133.33 MHz PLL mode (Notes 5)	132.33	133.33	134.33	MHz
L _{PIN}	Pin Inductance	(Note 3)			7	nΗ
C _{IN}		Logic Inputs, except CLK_IN (Note 3)	1.5		5	pF
C _{INDIF_IN}	Capacitance	CLK_IN differential clock inputs (Notes 3 and 7)	1.5		2.7	pF
C _{OUT}		Output pin capacitance (Note 3)			6	pF
T _{STAB}	Clk Stabilization	From V _{DD} Power–Up and after input clock stabilization or de–assertion of PD# to 1st clock (Notes 3 and 5)			1.8	ms
f	Input SS Modulation Frequency	Allowable Frequency (Triangular Modulation) (Note 3)	30		33	kHz
t _{LATOE} #	OE# Latency	DIF start after OE# assertion DIF stop after OE# de-assertion (Note 3)	4		12	cycles
t _{DRVPD}	Tdrive_PD#	DIF output enable after PD# de-assertion (Note 3)			300	μS
t _F	Tfall	Fall time of control inputs (Notes 3 and 5)			5	ns
t _R	Trise	Rise time of control inputs (Notes 3 and 5)			5	ns
V_{ILSMB}	SMBus Input Low Voltage	(Note 3)			0.8	V
V _{IHSMB}	SMBus Input High Voltage	(Note 3)	2.1		V_{DDSMB}	V
V _{OLSMB}	SMBus Output Low Voltage	@ I _{PULLUP} (Note 3)			0.4	V
I _{PULLUP}	SMBus Sink Current	@ V _{OL} (Note 3)	4			mA
V_{DDSMB}	Nominal Bus Voltage	3 V to 5 V ±10% (Note 3)	2.7		5.5	V
t _{RSMB}	SCL/SDA Rise Time	(Max V _{IL} – 0.15) to (Min V _{IH} + 0.15) (Note 3)			1000	ns
t _{FSMB}	SCL/SDA Fall Time	(Min VIH + 0.15) to (Max V _{IL} - 0.15) (Note 3)			300	ns
f _{MAXSMB}	SMBus Operating Frequency	Maximum SMBus operating frequency (Notes 3 and 8)			100	kHz

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

3. Guaranteed by design and characterization, not tested in production.

- 4. 100M_133M# Frequency Select (FS).
- 5. Control input must be monotonic from 20% to 80% of input swing.
- 6. Fmax measured until output violates output duty cycle specifications and output V_{High}, V_{Low} specification.
- 7. CLK_IN input
- 8. The differential input clock must be running for the SMBus to be active.

Table 10. ELECTRICAL CHARACTERISTICS - CLOCK INPUT PARAMETERS

(V_{DD} = V_{DDA} = 3.3 V \pm 5%, T_A = -10°C to +70°C), See Test Loads for Loading Conditions.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{IHDIF}	Input High Voltage – CLK_IN (Note 9)	Differential inputs (single-ended measurement)	600		1150	mV
V _{ILDIF}	Input Low Voltage – CLK_IN (Note 9)	Differential inputs (single-ended measurement)	V _{SS} - 300		300	mV
V _{COM}	Input Common Mode Voltage – CLK_IN (Note 9)	Common Mode Input Voltage	300		1000	mV
V _{SWING}	Input Amplitude – CLK_IN (Note 9)	Peak to Peak value	300		1450	mV
dv/dt	Input Slew Rate – CLK_IN (Notes 9 and 10)	Measured differentially	0.4		8	V/ns
I _{IN}	Input Leakage Current (Note 9)	$V_{IN} = V_{DD}, V_{IN} = GND$	- 5		5	μΑ
d _{tin}	Input Duty Cycle (Note 9)	Measurement from differential waveform	45		55	%
J _{DIFIn}	Input Jitter – Cycle to Cycle (Note 9)	Differential Measurement	0		125	ps

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Table 11. ELECTRICAL CHARACTERISTICS - DIF 0.7 V CURRENT MODE DIFFERENTIAL OUTPUTS

 $(V_{DD} = V_{DDA} = 3.3 \text{ V} \pm 5\%$, $T_A = -10^{\circ}\text{C}$ to $+70^{\circ}\text{C}$), See Test Loads for Loading Conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
dV/dt	Slew rate (Notes 11, 12 and 13)	Scope averaging on	1		4	V/ns
∆dV/dt	Slew rate matching (Notes 11, 12 and 14)	Slew rate matching, Scope averaging on			20	%
ΔTrf	Rise/Fall Time Matching (Notes 11, 12 and 18)	Rise/fall matching, Scope averaging off			125	ps
V_{High}	Voltage High (Note 11)	Statistical measurement on single-ended	660		850	.,
V_{Low}	Voltage Low (Note 11)	signal using oscilloscope math function. (Scope averaging on)	-150		150	mV
V _{max}	Max Voltage (Note 11)	Measurement on single ended signal using			1150	m\/
V_{min}	Min Voltage (Note 11)	Absolute value. (Scope averaging off)	-300			mV
V_{swing}	Vswing (Notes 11 and 12)	Scope averaging off	300			mV
V _{cross_abs}	Crossing Voltage (abs) (Notes 11 and 15)	Scope averaging off	250		550	mV
ΔV_{cross}	Crossing Voltage (var) (Notes 11 and 16)	Scope averaging off			140	mV

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

^{9.} Guaranteed by design and characterization, not tested in production.

^{10.} Slew rate measured through ± 75 mV window centered around differential zero.

^{11.} Guaranteed by design and characterization, not tested in production. $I_{REF} = V_{DD}/(3xR_{REF})$. For $R_{REF} = 475 \Omega$ (1%), $I_{REF} = 2.32$ mA. $I_{OH} = 6 \times I_{REF}$ and $V_{OH} = 0.7 \text{ V}$ @ $Z_{O} = 50 \Omega$ (100 Ω differential impedance).

^{12.} Measured from differential waveform.

^{13.} Slew rate is measured through the Vswing voltage range centered around differential 0 V. This results in a ±150 mV window around differential 0 V.

^{14.} Matching applies to rising and falling edge rate of differential waveform. It is measured using a ± 75 mV window centered on the average cross point where the clock rising meets clock# falling. The median cross point is used to calculate voltage thresholds that the oscilloscope uses to calculate the slew rate. Measurement taken using a 100 Ω differential impedance 5" trace PCB.

^{15.} Vcross is defined as voltage where Clock = Clock# measured on a component test board and only applies to the differential rising edge (i.e. Clock rising and Clock# falling).

^{16.} The total variation of all Vcross measurements in any particular system. Note that this is a subset of V_cross_min/max (V_cross absolute) allowed. The intent is to limit Vcross induced modulation by setting V_cross_delta to be smaller than V_cross absolute.

^{17.} Measured from single-ended waveform

^{18.} Measured with scope averaging off, using statistics function. Variation is difference between min and max.

Table 12. ELECTRICAL CHARACTERISTICS - CURRENT CONSUMPTION

 $(V_{DD} = V_{DDA} = 3.3 \text{ V} \pm 5\%$, $T_A = -10^{\circ}\text{C}$ to $+70^{\circ}\text{C}$), See Test Loads for Loading Conditions

Symbol	Parameter	neter Conditions		Тур	Max	Unit
I _{DD3.3OP}	Operating Supply Current (Note 19)	All outputs active $@$ 100.00 MHz, $C_L = Full\ load$			550	mA
I _{DD3.3PDZ}	Powerdown Current (Note 19)	All differential pairs tri-stated			36	mA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

19. Guaranteed by design and characterization, not tested in production.

Table 13. ELECTRICAL CHARACTERISTICS - SKEW AND DIFFERENTIAL JITTER PARAMETERS

 $(V_{DD} = V_{DDA} = 3.3 \text{ V} \pm 5\%$, $T_A = -10^{\circ}\text{C}$ to $+70^{\circ}\text{C}$), See Test Loads for Loading Conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
t _{SPO_PLL}	CLK_IN, DIF[x:0] (Notes 20, 21, 23, 24 and 27)	Input-to-Output Skew in PLL mode nominal value @ 25°C, 3.3 V	-100		100	ps
t _{PD_BYP}	CLK_IN, DIF[x:0] (Notes 20, 21, 22, 24 and 27)	Input-to-Output Skew in Bypass mode nominal value @ 25°C, 3.3 V	2.5		4.5	ns
t _{DSPO_PLL}	CLK_IN, DIF[x:0] (Notes 20, 21, 22, 24 and 27)	Input-to-Output Skew Variation in PLL mode across voltage and temperature			100	ps
t _{DSPO_BYP}	CLK_IN, DIF[x:0] (Notes 20, 21, 22, 24 and 27)	Input–to–Output Skew Variation in Bypass mode across voltage and temperature	-250		250	ps
t _{SKEW_ALL}	DIF{x:0] (Notes 20, 21, 22 and 27)	Output-to-Output Skew across all outputs (Common to Bypass and PLL mode)			65	ps
jpeak-hibw	PLL Jitter Peaking (Notes 26 and 27)	HBW_BYP_LBW# = 1	0		2.5	dB
jpeak-lobw	PLL Jitter Peaking (Notes 26 and 27)	HBW_BYP_LBW# = 0	0		2	dB
pll _{HIBW}	PLL Bandwidth (Notes 27 and 28)	HBW_BYP_LBW# = 1	2		4	MHz
pll _{LOBW}	PLL Bandwidth (Notes 27 and 28)	HBW_BYP_LBW# = 0	0.7		1.4	MHz
t _{DC}	Duty Cycle (Notes 20 and 27)	Measured differentially, PLL Mode	45	50	55	%
t _{DCD}	Duty Cycle Distortion (Notes 20 and 29)	Measured differentially, Bypass Mode @ 100.00 MHz	-2	0	2	%
	Jitter, Cycle to cycle	PLL mode			50	ps
^t jcyc–cyc	(Notes 20, 27 and 30)	Additive Jitter in Bypass Mode			50	ps

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

- 20. Measured into fixed 2 pF load cap. Input to output skew is measured at the first output edge following the corresponding input.
- 21. Measured from differential cross-point to differential cross-point. This parameter can be tuned with external feedback path, if present.
- 22. All Bypass Mode Input-to-Output specs refer to the timing between an input edge and the specific output edge created by it.
- 23. This parameter is deterministic for a given device.
- 24. Measured with scope averaging on to find mean value. CLK_IN slew rate must be matched to DIF output slew rate.
- 25.t is the period of the input clock.
- 26. Measured as maximum pass band gain. At frequencies within the loop BW, highest point of magnification is called PLL jitter peaking.
- 27. Guaranteed by design and characterization, not tested in production.
- 28. Measured at 3 db down or half power point.
- 29. Duty cycle distortion is the difference in duty cycle between the output and the input clock when the device is operated in bypass mode. @ 100.00 MHz.
- 30. Measured from differential waveform.

Table 14. ELECTRICAL CHARACTERISTICS - PHASE JITTER PARAMETERS

 $(V_{DD} = V_{DDA} = 3.3 \text{ V} \pm 5\%$, $T_A = -10^{\circ}\text{C}$ to $+70^{\circ}\text{C}$), See Test Loads for Loading Conditions.

Symbol	Parameter	Conditions (Notes 31 and 36)	Min	Тур	Max	Unit
t _{jphPCleG1}		PCIe Gen 1 (Notes 32 and 33)		36	86	ps (p-p)
		PCIe Gen 2 Lo Band 10 kHz < f < 1.5 MHz (Note 32)			3	ps (rms)
t _{jph} PCleG2		PCIe Gen 2 High Band 1.5 MHz < f < Nyquist (50 MHz) (Note 32)			3.1	ps (rms)
t _{jph} PCleG3	Jitter, Phase	PCIe Gen 3 (PLL BW of 2–4 MHz, CDR = 10 MHz) (Note 32)			1	ps (rms)
	PI_SMI	QPI & SMI (100.00 MHz or 133.33 MHz, 4.8 Gb/s, 6.4 Gb/s 12UI) (Note 34)			0.5	ps (rms)
tjphQPI_SMI		QPI & SMI (100.00 MHz, 8.0 Gb/s, 12UI) (Note 34)			0.3	ps (rms)
		QPI & SMI (100.00 MHz, 9.6 Gb/s, 12UI) (Note 34)			0.2	ps (rms)
t _{jphPCleG1}		PCIe Gen 1 (Notes 32 and 33)			10	ps (p-p)
		PCIe Gen 2 Lo Band 10 kHz < f < 1.5 MHz (Notes 32 and 35)			0.3	ps (rms)
t _{jphPCleG2}		PCIe Gen 2 High Band 1.5 MHz < f < Nyquist (50 MHz) (Notes 32 and 35)			0.7	ps (rms)
t _{jphPCleG3}	Additive Phase Jitter, Bypass mode	PCIe Gen 3 (PLL BW of 2–4 MHz, CDR = 10 MHz) (Notes 32 and 35)			0.3	ps (rms)
^t jphQPI_SMI		QPI & SMI (100.00 MHz or 133.33 MHz, 4.8 Gb/s, 6.4 Gb/s 12UI) (Notes 34 and 35)			0.3	ps (rms)
		QPI & SMI (100.00 MHz, 8.0 Gb/s, 12UI) (Notes 34 and 35)			0.1	ps (rms)
		QPI & SMI (100.00 MHz, 9.6 Gb/s, 12UI) (Notes 34 and 35)			0.1	ps (rms)

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 31.Applies to all outputs.

^{32.} See http://www.pcisig.com for complete specs

^{33.} Sample size of at least 100K cycles. This figures extrapolates to 108 ps pk-pk @ 1M cycles for a BER of 1–12. 34. Calculated from Intel-supplied Clock Jitter Tool v 1.6.3.

^{35.} For RMS figures, additive jitter is calculated by solving the following equation: (Additive jitter)² = (total jitter)² - (input jitter)² 36. Guaranteed by design and characterization, not tested in production

Table 15. CLOCK PERIODS - DIFFERENTIAL OUTPUTS WITH SPREAD SPECTRUM DISABLED

				M	easurement	Window				
		1 Clock	1us	0.1s	0.1s	0.1s	1us	1 Clock		
SSC OFF	Center Freq. MHz	AbsPer	–SSC Short–Term Average Min	– ppm Long–Term Average Min	0 ppm Period Nominal	+ ppm Long- Term Average Max	+SSC Short-Term Average Max	+c2c jitter AbsPer Max	Unit	Notes
DIF	100.00	9.94900		9.99900	10.00000	10.00100		10.05100	ns	37, 38, 39
DIF	133.33	7.44925		7.49925	7.50000	7.50075		7.55075	ns	37, 38, 40

^{37.} Guaranteed by design and characterization, not tested in production.

Table 16. CLOCK PERIODS - DIFFERENTIAL OUTPUTS WITH SPREAD SPECTRUM ENABLED

				М	easurement	Window				
		1 Clock	1us	0.1s	0.1s	0.1s	1us	1 Clock		
SSC ON	Center Freq. MHz	AbsPer	–SSC Short–Term Average Min	– ppm Long–Term Average Min	0 ppm Period Nominal	+ ppm Long-Term Average Max	+SSC Short-Term Average Max	+c2c jitter AbsPer Max	Unit	Notes
DIF	99.75	9.94906	9.99906	10.02406	10.02506	10.02607	10.05107	10.10107	ns	41, 42, 43
DIF	133.00	7.44930	7.49930	7.51805	7.51880	7.51955	7.53830	7.58830	ns	41, 42, 44

^{41.} Guaranteed by design and characterization, not tested in production.

Table 17. POWER MANAGEMENT TABLE

Inpu	ts	Control Bits/Pins				Outputs	
PWRGD/PWRDN#	CLK_IN/CLK_IN#	SMBus EN bit	OE# Pin	DIF(5:12) / DIF(5:12)#	Other DIF/ DIF#	FB_OUT / FB_OUT#	PLL State
0	Х	Х	Х	Hi-Z (Note 45)	Hi-Z (Note 45)	Hi-Z (Note 45)	OFF
		0	Х	Hi-Z (Note 45)	Hi-Z (Note 45)	Running	ON
1	Running	1	0	Running	Running	Running	ON
	rtaining	1	1	Hi-Z (Note 45)	Running	Running	ON

^{45.} Due to external pull down resistors, HI-Z results in Low/Low on the True/Complement outputs

^{38.} All Long Term Accuracy specifications are guaranteed with the assumption that the input clock complies with CK420BQ/CK410B+ accuracy requirements (±100 ppm). The 9ZX21901 itself does not contribute to ppm error.

^{39.} Driven by SRC output of main clock, 100.00 MHz PLL Mode or Bypass mode

^{40.} Driven by CPU output of main clock, 133.33 MHz PLL Mode or Bypass mode

^{42.} All Long Term Accuracy specifications are guaranteed with the assumption that the input clock complies with CK420BQ/CK410B+ accuracy requirements (±100 ppm). The 9ZX21901 itself does not contribute to ppm error.

^{43.} Driven by SRC output of main clock, 100.00 MHz PLL Mode or Bypass mode

^{44.} Driven by CPU output of main clock, 133.33 MHz PLL Mode or Bypass mode

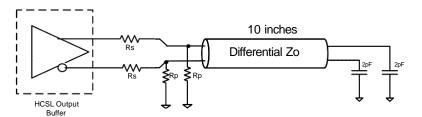


Figure 3. NB3N1900K Differential Test Loads

Table 18. DIFFERENTIAL OUTPUT TERMINATION TABLE

DIF Zo (Ω)	DIF Zo (Ω) Iref (Ω)		Rp (Ω)
100	475	33	50
85	412	27	42.2 or 43.2

PWRGD/PWRDN#

PWRGD/PWRDN# is a dual function pin. PWRGD is asserted high and de—asserted low. De—assertion of PWRGD (pulling the signal low) is equivalent to indicating a powerdown condition. PWRGD (assertion) is used by the NB3N1900K to sample initial configurations such as frequency select condition and SA selections.

After PWRGD has been asserted high for the first time, the pin becomes a PWRDN# (Power Down) pin that can be used to shut off all clocks cleanly and instruct the device to invoke power savings mode. PWRDN# is a completely asynchronous active low input. When entering power savings mode, PWRDN# should be asserted low **prior to shutting off the input clock or power** to ensure all clocks shut down in a glitch free manner. When PWRDN# is

asserted low by two consecutive rising edges of DIF#, all differential outputs are held tri-stated on the next DIF# high to low transition. The assertion and de-assertion of PWRDN# is absolutely asynchronous.

WARNING: Disabling of the CLK_IN input clock prior to assertion of PWRDN# is an undefined mode and not recommended. Operation in this mode may result in glitches, excessive frequency shifting, etc.

Table 19. PWRGD/PWRDN# FUNCTIONALITY

PWRGD/PWRDN#	DIF	DIF#
0	Tri-state	Tri-state
1	Running	Running

Buffer Power-Up State Machine

Table 20. BUFFER POWER-UP STATE MACHINE

State	Description
0	3.3 V Buffer power off
1	After 3.3 V supply is detected to rise above 3.135 V, the buffer enters State 1 and initiates a 0.1 ms-0.3 ms delay.
2	Buffer waits for a valid clock on the CLK input and PWRDN# de-assertion (or PWRGD assertion low to high)
3	Once the PLL is locked to the CLK_IN input clock, the buffer enters state 3 and enables outputs for normal operation. (Notes 46, 47)

46. The total power up latency from power on to all outputs active must be less than 1.8 ms (assuming a valid clock is present on CLK_IN input). 47. If power is valid and powerdown is de-asserted (PWRGD asserted) but no input clocks are present on the CLK_IN input, DIF clocks must remain disabled. Only after valid input clocks are detected, valid power, PWRDN# de-asserted (PWRGD asserted) with the PLL locked/stable and the DIF outputs enabled.

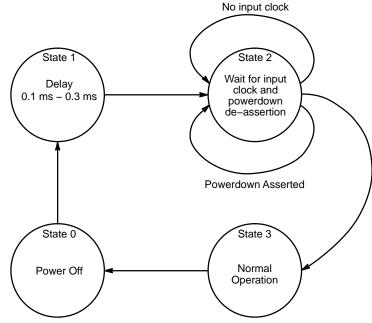


Figure 4. Buffer Power-Up State Diagram

Device Power-Up Sequence

Follow the power–up sequence below for proper device functionality:

- 1. PWRGD/PWRDN# pin must be Low.
- 2. Assign remaining control pins to their required state (100M_133M#, HBW_BYPASS_LBW#, SDA, SCL)
- 3. Apply power to the device.
- 4. Once the VDD pin has reached a valid VDDmin level (3.3V –5%), the PWRGD/PWRDN# pin must be asserted High. See Figure 5.

Note: If no clock is present on the CLK_IN/CLK_IN# pins when device is powered up, there will be no clock on DIF/DIF# outputs.

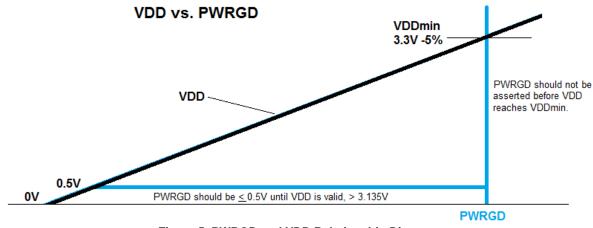


Figure 5. PWRGD and VDD Relationship Diagram

GENERAL SMBUS SERIAL INTERFACE INFORMATION FOR THE NB3N1900K

How to Write:

- Controller (host) sends a start bit.
- Controller (host) sends the write address XX_(H)
- Clock(device) will acknowledge
- Controller (host) sends the beginning byte location = N
- Clock(device) will acknowledge
- Controller (host) sends the data byte count = X
- Clock(device) will acknowledge
- Controller (host) starts sending Byte N through Byte N+X−1
- Clock(device) will acknowledge each byte one at a time
- Controller (host) sends a Stop bit

Table 21. INDEX BLOCK WRITE OPERATION

Controlle	r (Host)	Clock	(Device)	
Т	starT bit			
Slave Addr	ess XX _(H)			
WR	WRite			
		А	CK	
Beginning	Byte = N			
		А	CK	
Data Byte (Count = X			
		ACK		
Beginning	Byte N			
			ACK	
0		X Byte	0	
0		A Byte	0	
			0	
Byte N -	+ X - 1			
		А	CK	
Р	stoP bit			

Note: XX(H) is defined by SMBus address select pins

How to Read:

- Controller (host) will send start bit.
- Controller (host) sends the write address XX_(H)
- Clock(device) will acknowledge
- Controller (host) sends the beginning byte location = N

- Clock(device) will acknowledge
- Controller (host) will send a separate start bit.
- Controller (host) sends the read address YY_(H)
- Clock(device) will acknowledge
- vclock will send the data byte count = X
- Clock(device) sends Byte N + X 1
- Clock(device) sends Byte 0 through byte X (if X_(H) was written to byte 8).
- Controller (host) will need to acknowledge each byte
- Controller (host) will send a not acknowledge bit
- Controller (host) sends a Stop bit

Table 22. INDEX BLOCK READ OPERATION

Controlle	er (Host)	Clock	k (Device)	
Т	starT bit			
Slave Add	ress XX _(H)			
WR	WRite			
			ACK	
Beginning	Byte = N			
			ACK	
RT	Repeat starT			
Slave Add	ress YY _(H)			
RD	ReaD			
		ACK		
		Data By	rte Count = X	
AC	K			
			Beginning Byte N	
AC	K			
			0	
C)	X Byte	0	
C)		0	
0				
			Byte N + X - 1	
N	Not acknowledge			
Р	stoP bit			

Note: XX_(H) is defined by SMBus address select pins

Table 23. SMBusTable: PLL MODE, AND FREQUENCY SELECT REGISTER

Byte 0	Pin#	Name	Control Function Type 0 1		1	Default	
Bit 7	5	PLL Mode 1	PLL Operating Mode Rd back 1	R	See PLL Ope	erating Mode	Latch
Bit 6	5	PLL Mode 0	PLL Operating Mode Rd back 0	R	Readba	Readback Table	
Bit 5	72/71	DIF_18_En	Output Control overrides OE# pin	RW	Hi–Z	Enable	1
Bit 4	70/69	DIF_17_En	Output Control overrides OE# pin	RW	Hi–Z	Enable	1
Bit 3	67/66	DIF_16_En	Output Control overrides OE# pin	RW	Hi–Z	Enable	1
Bit 2			Reserved				0
Bit 1		Reserved					
Bit 0	4	100M_133M#	Frequency Select Readback	R	133 MHz	100 MHz	Latch

Table 24. SMBusTable: OUTPUT CONTROL REGISTER

Byte 1	Pin#	Name	Control Function	Туре	0	1	Default
Bit 7	39/38	DIF_7_En	Output Control overrides OE# pin	RW			1
Bit 6	35/36	DIF_6_En	Output Control overrides OE# pin	RW			1
Bit 5	32/33	DIF_5_En	Output Control overrides OE# pin	RW			1
Bit 4	29/30	DIF_4_En	Output Control overrides OE# pin	RW	Hi–Z	Enable	1
Bit 3	27/28	DIF_3_En	Output Control overrides OE# pin	RW	⊓I–Z	Enable	1
Bit 2	24/25	DIF_2_En	Output Control overrides OE# pin	RW			1
Bit 1	22/23	DIF_1_En	Output Control overrides OE# pin	RW	1		1
Bit 0	19/20	DIF_0_En	Output Control overrides OE# pin	RW			1

Table 25. SMBusTable: OUTPUT CONTROL REGISTER

Byte 2	Pin#	Name	Control Function Type		0	1	Default
Bit 7	65/64	DIF_15_En	Output Control overrides OE# pin	RW			1
Bit 6	62/61	DIF_14_En	Output Control overrides OE# pin	RW			1
Bit 5	60/59	DIF_13_En	Output Control overrides OE# pin	RW			1
Bit 4	56/55	DIF_12_En	Output Control overrides OE# pin	RW	Hi–Z	Enable	1
Bit 3	53/52	DIF_11_En	Output Control overrides OE# pin	RW	111-2	Enable	1
Bit 2	50/49	DIF_10_En	Output Control overrides OE# pin	RW			1
Bit 1	47/46	DIF_9_En	Output Control overrides OE# pin	RW			1
Bit 0	42/41	DIF_8_En	Output Control overrides OE# pin	RW			1

Table 26. SMBusTable: OUTPUT ENABLE PIN STATUS READBACK REGISTER

Byte 3	Pin #	Name Control Function Type		Туре	0	1	Default
Bit 7	57	OE_RB12	Real Time readback of OE#12	R			Real time
Bit 6	54	OE_RB11	Real Time readback of OE#11	R			Real time
Bit 5	51	OE_RB10	Real Time readback of OE#10	R			Real time
Bit 4	48	OE_RB9	Real Time readback of OE#9	R	OF# =:= =	OE# Pin High	Real time
Bit 3	43	OE_RB8	Real Time readback of OE#8	R	OE# pin Low		Real time
Bit 2	40	OE_RB7	Real Time readback of OE#7	R			Real time
Bit 1	37	OE_RB6	Real Time readback of OE#6	R	1		Real time
Bit 0	34	OE_RB5	Real Time readback of OE#5	R			Real time

Table 27. SMBusTable: RESERVED REGISTER

Byte 4	Pin#	Name	Control Function	Туре	0	1	Default			
Bit 7		Reserved								
Bit 6		Reserved								
Bit 5		Reserved								
Bit 4		Reserved								
Bit 3			Reserved				0			
Bit 2			Reserved				0			
Bit 1		Reserved								
Bit 0			Reserved				0			

Table 28. SMBusTable: VENDOR & REVISION ID REGISTER

Byte 5	Pin#	Name	Control Function	Туре	0	1	Default
Bit 7	-	RID3		R			Х
Bit 6	-	RID2	REVISION ID	R		Х	
Bit 5	-	RID1	REVISION ID	R	-	Х	
Bit 4	-	RID0		R		Х	
Bit 3	-	VID3		R	-	-	1
Bit 2	-	VID2	VENDOR ID	R	-	-	1
Bit 1	-	VID1	VENDOR ID	R	-	-	1
Bit 0	_	VID0		R	-	-	1

Table 29. SMBusTable: DEVICE ID

Byte 6	Pin#	Name	Control Function	Туре	0	1	Default	
Bit 7	-		Device ID 7 (MSB)	R		•	1	
Bit 6	-		R					
Bit 5	-		Device ID 5	R			0	
Bit 4	-		Device ID 4	R	Device ID is 1	1		
Bit 3	-		Device ID 3	R	78 1	1		
Bit 2	-		Device ID 2	R		0		
Bit 1	-	Device ID 1		R		1		
Bit 0	-		Device ID 0	R	7		1	

Table 30. SMBusTable: BYTE COUNT REGISTER

Byte 7	Pin #	Name	Control Function	Type	0	1	Default			
Bit 7			Reserved							
Bit 6			Reserved							
Bit 5			Reserved							
Bit 4	-	BC4		RW		0				
Bit 3	-	BC3		RW	Default value	1				
Bit 2	-	BC2	Writing to this register configures how many bytes will be read back.	RW	bytes (0 to 8	0				
Bit 1	-	BC1		RW	back by	0				
Bit 0	1	BC0	RW							

Table 31. SMBusTable: RESERVED REGISTER

Byte 8	Pin #	Name	Control Function	Туре	0	1	Default			
Bit 7		Reserved								
Bit 6		Reserved								
Bit 5		Reserved								
Bit 4		Reserved								
Bit 3			Reserved				0			
Bit 2			Reserved				0			
Bit 1		Reserved								
Bit 0			Reserved				0			

DIF Reference Clock						
Common Recommendations for Differential Routing	Dimension or Value	Unit				
L1 length, route as non–coupled 50 Ω trace (Figure 6)	0.5 max	inch				
L2 length, route as non–coupled 50 Ω trace (Figure 6)	0.2 max	inch				
L3 length, route as non–coupled 50 Ω trace (Figure 6)	0.2 max	inch				
Rs (Figure 6)	33	Ω				
Rt (Figure 6)	49.9	Ω				

Down Device Differential Routing		
L4 length, route as coupled microstrip 100 Ω differential trace (Figure 6)	2 min to 16 max	inch
L4 length, route as coupled stripline 100 Ω differential trace (Figure 6)	1.8 min to 14.4 max	inch

Differential Routing to PCI Express Connector		
L4 length, route as coupled microstrip 100 Ω differential trace (Figure 7)	0.25 to 14 max	inch
L4 length, route as coupled stripline 100 Ω differential trace (Figure 7)	0.225 min to 12.6 max	inch

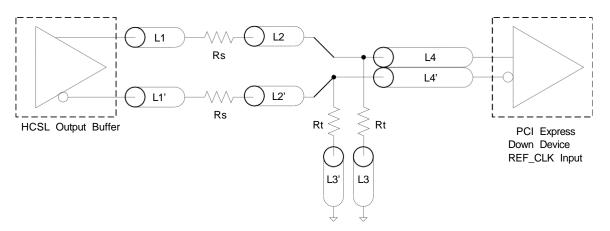


Figure 6. Down Device Routing

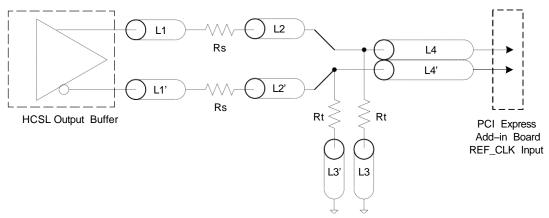


Figure 7. PCI Express Connector Routing

Table 32. ALTERNATIVE TERMINATION FOR LVDS AND OTHER COMMON DIFFERENTIAL SIGNALS (Figure 8)

Vdiff (V)	Vpp (V)	Vcm (V)	R1 (Ω)	R2 (Ω)	R3 (Ω)	R4 (Ω)	Note
0.45	0.22	1.08	33	150	100	100	
0.58	0.28	0.6	33	78.7	137	100	
0.60	0.3	1.2	33	174	140	100	Standard LVDS

R1a = R1b = R1R2a = R2b = R2

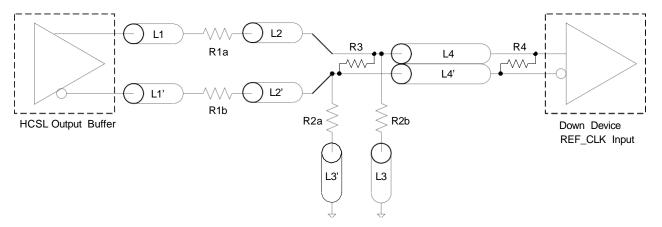


Figure 8. Alternate Termination for LVDS

Table 33. CABLE CONNECTED AC COUPLED APPLICATION (Figure 9)

Component	Value	Note
R5a, R5b	8.2k 5%	
R6a, R6b	1k 5%	
Сс	0.1 μF	
Vcm	0.350 V	

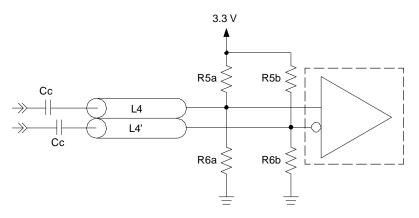


Figure 9. Cable-Connected AC Coupled Application

POWER FILTERING EXAMPLE

Ferrite Bead Power Filtering

Recommended ferrite bead filtering equivalent to the following: 600 Ω impedance at 100 MHz, \leq 0.1 Ω DCR max., \geq 800 mA current rating.

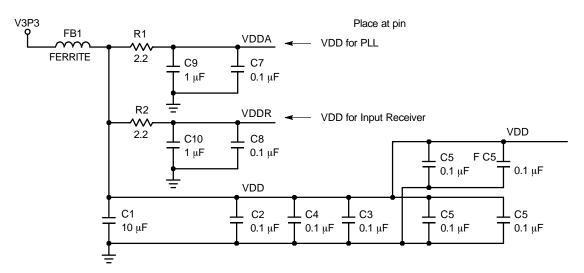


Figure 10. Schematic Example of the NB3N1900K Power Filtering

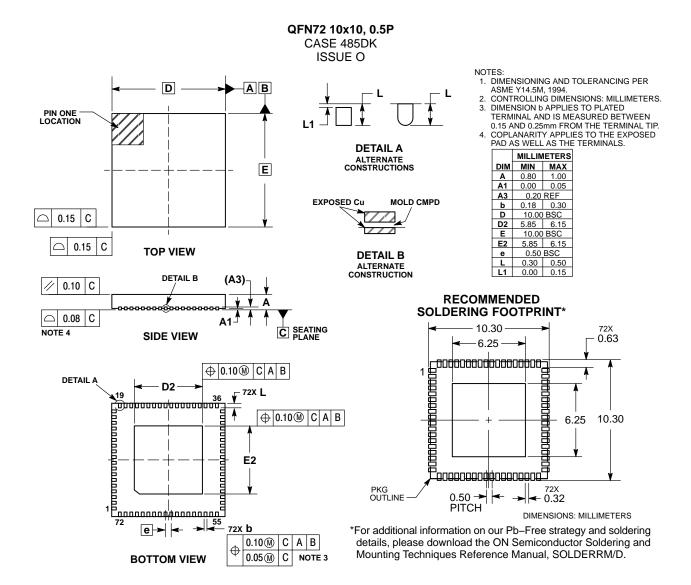
Table 34. ORDERING INFORMATION

Device	Package	Shipping [†]
NB3N1900KMNG	QFN-72 (Pb-Free)	168 Units / Tray
NB3N1900KMNTXG	QFN-72 (Pb-Free)	1000 / Tape & Reel
NB3N1900KMNTWG	QFN-72 (Pb-Free)	1000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

NOTE: Pin 1 orientation for TWG Suffix is Quadrant 1, upper left; Pin 1 orientation for TXG Suffix is Quadrant 2, upper right

PACKAGE DIMENSIONS



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